

PC824/PC844

AC Input Photocoupler

* Lead forming type (I type) and taping reel type (P type) are also available.

■ Features

1. AC input
2. High isolation voltage between input and output ($V_{iso(rms)}$:5kV)
3. Compact dual-in-line package
PC824 (2-channel type)
PC844 (4-channel type)
4. Current transfer ratio
 CTR:MIN. 20% at $I_F=\pm 1mA, V_{CE}=5V$
5. Recognized by UL, file No. E64380

■ Applications

1. Programmable controllers
2. Telephones
3. Facsimiles

■ Absolute Maximum Ratings (T_a=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_F	± 50	mA
	*1 Peak forward current	I_{FM}	± 1	A
	Power dissipation	P	70	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	50	mA
	Collector power dissipation	P_C	150	mW
	Total power dissipation	P_{tot}	200	mW
	*2 Isolation voltage	$V_{iso(rms)}$	5	kV
	Operating temperature	T_{opr}	-30 to +100	°C
	Storage temperature	T_{stg}	-55 to +125	°C
*3 Soldering temperature	T_{sol}	260	°C	

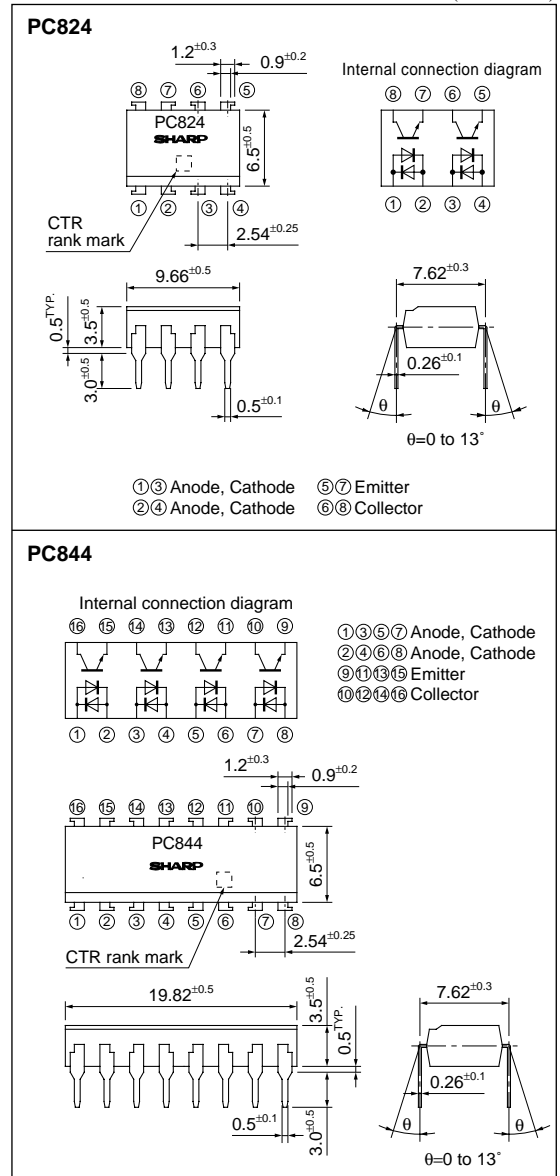
*1 Pulse width $\leq 100\mu s$, Duty ratio:0.001

*2 40 to 60%RH, AC for 1 minute

*3 For 10s

■ Outline Dimensions

(Unit : mm)



■ Electro-optical Characteristics

(T_a=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F	I _F =±20mA	–	1.2	1.4	V
	Peak forward voltage	V _{FM}	I _{FM} =±0.5V	–	–	3.0	V
	Terminal capacitance	C _t	V=0, f=1kHz	–	50	250	pF
Output	Collector dark current	I _{CEO}	V _{CE} =20V, I _F =0	–	–	100	nA
Transfer characteristics	Collector current	I _C	I _F =±1mA, V _{CE} =5V	0.2	–	3.0	mA
	Collector-emitter saturation voltage	V _{CE(sat)}	I _F =±20mA, I _C =1mA	–	0.1	0.2	V
	Isolation resistance	R _{ISO}	DC500V, 40 to 60%RH	5×10 ¹⁰	10 ¹¹	–	Ω
	Floating capacitance	C _f	V=0, f=1MHz	–	0.6	1.0	pF
	Cut-off frequency	f _c	V _{CE} =5V, I _C =2mA, R _L =100Ω, -3dB	15	80	–	kHz
	Response time	Rise time	t _r	V _{CE} =2V, I _C =2mA, R _L =100Ω	–	4	18
Fall time		t _f	–		3	18	μs

■ Rank Table

(I_F=±1mA, V_{CE}=5V, T_a=25°C)

Model No.	Rank mark	I _C (mA)
PC824A	A	0.5 to 1.5
PC844A		
PC824	A or no mark	0.2 to 3.0
PC844		

Fig.1 Forward Current vs. Ambient Temperature

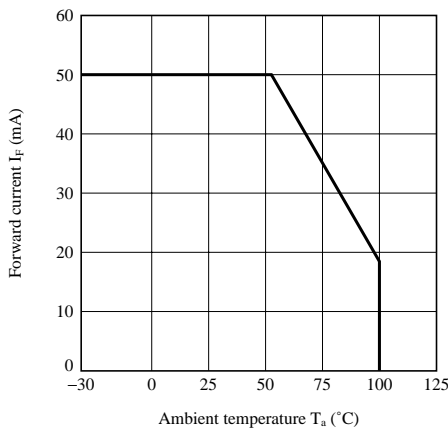


Fig.2 Collector Power Dissipation vs. Ambient Temperature

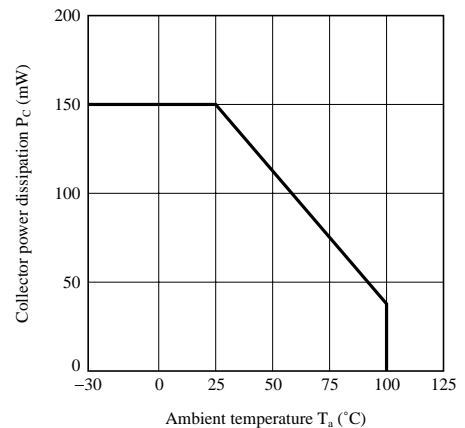


Fig.3 Peak Forward Current vs. Duty Ratio

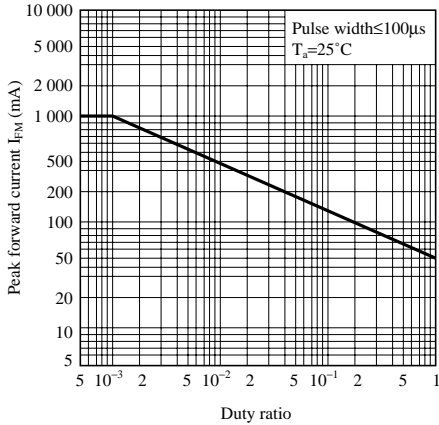


Fig.4 Forward Current vs. Forward Voltage

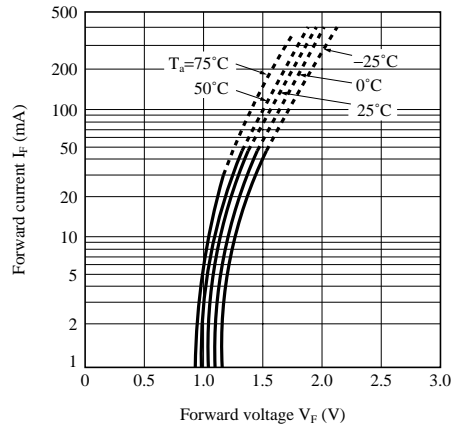


Fig.5 Current Transfer Ratio vs. Forward Current

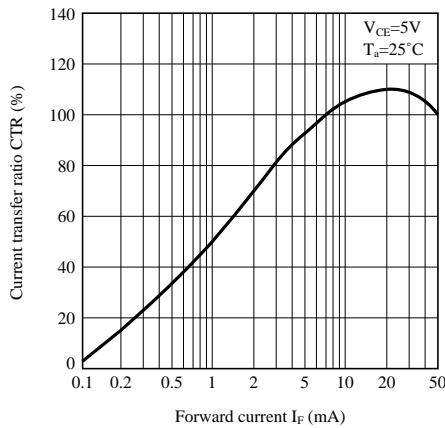


Fig.6 Collector Current vs. Collector-emitter Voltage

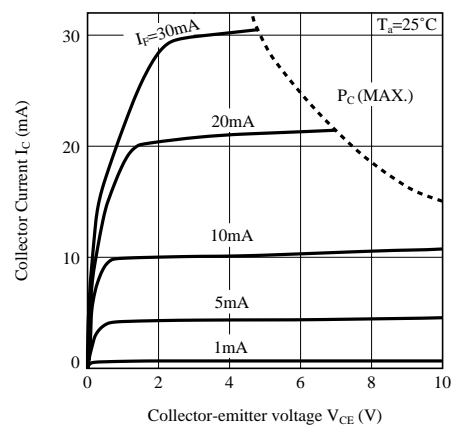


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

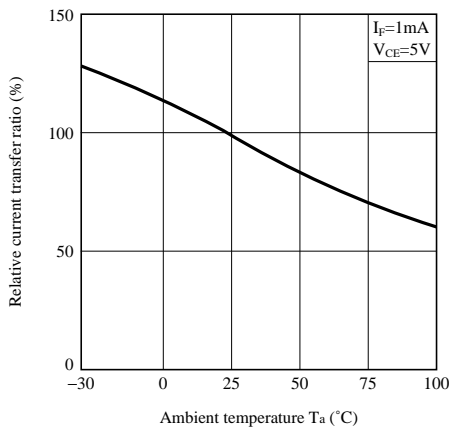


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

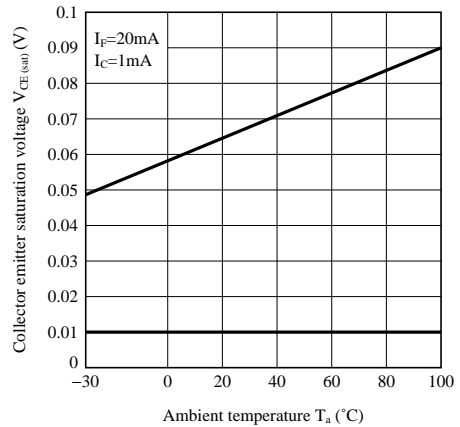


Fig.9 Collector Dark Current vs. Ambient Temperature

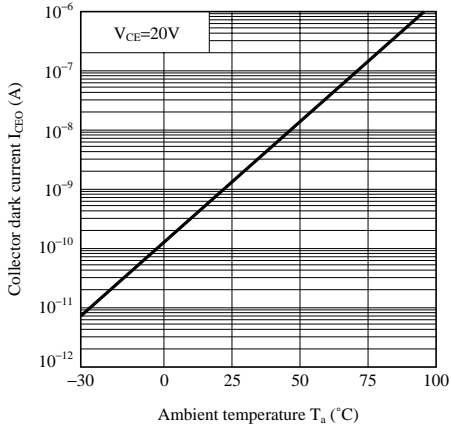


Fig.10 Collector-emitter Saturation Voltage vs. Forward Current

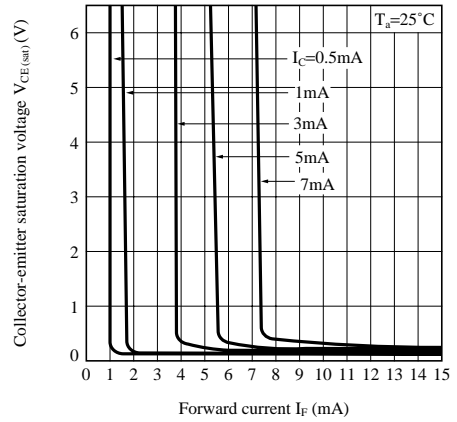
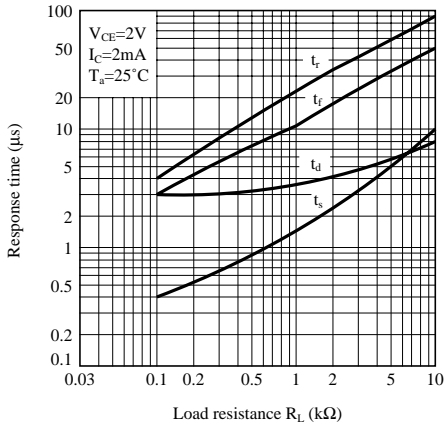


Fig.11 Response Time vs. Load Resistance



Test Circuit for Response Time

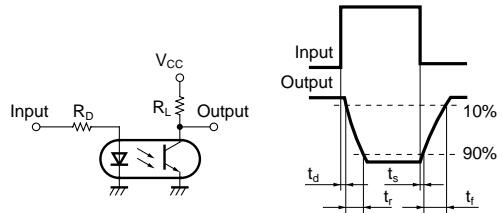
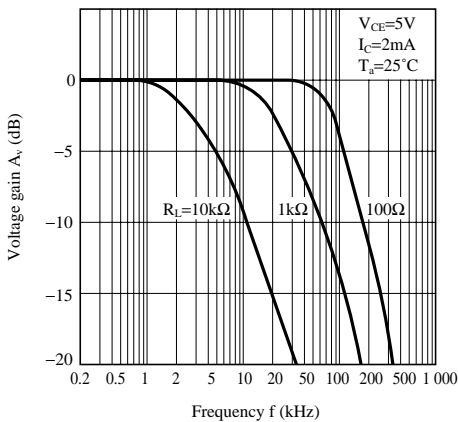
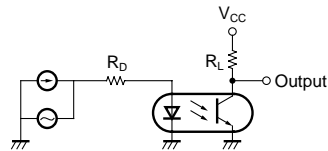


Fig.12 Frequency Response



Test Circuit for Frequency Response



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